

S05A30 THRU S05A60

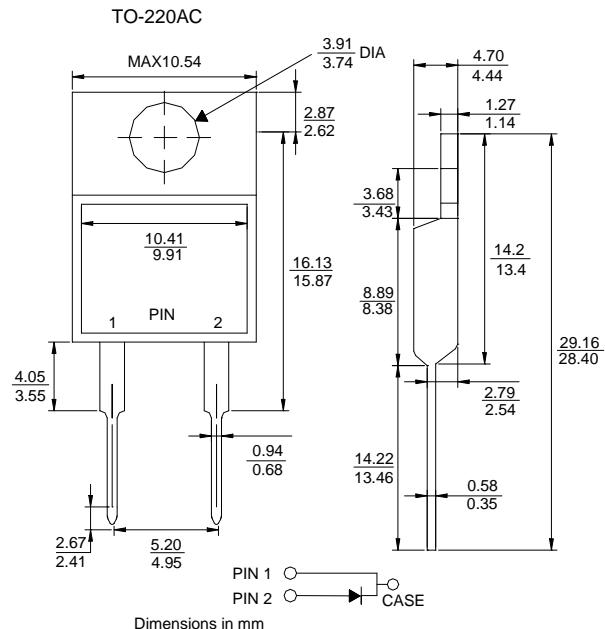
Schottky Barrier Rectifiers
Reverse Voltage – 30 to 60 V
Forward Current – 10.0 A

Features

- Plastic package carries Underwriters Laboratory Flammability Classification 94V-0
- Construction utilizes void-free molded plastic technique
- Low reverse leakage
- High forward surge current capability
- High temperature soldering guaranteed:
 $250^{\circ}\text{C}, 0.25"$ (6.35mm) from case for 10 seconds

Mechanical Data

- **Case:** Molded plastic body, TO-220AC
- **Terminals:** leads solderable per MIL-STD-750, method 2026
- **Polarity:** As marked
- **Mounting Position:** Any

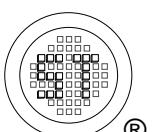


Absolute Maximum Ratings and Characteristics

Ratings at 25°C ambient temperature unless otherwise specified. Single phase half-wave 60Hz, resistive or inductive load. for capacitive load current derate by 20%.

	Symbols	S05A30	S05A40	S05A45	S05A50	S05A60	Units
Maximum repetitive peak reverse voltage	V_{RRM}	30	40	45	50	60	V
Maximum RMS voltage	V_{RMS}	21	28	32	35	42	V
Maximum DC blocking voltage	V_{DC}	30	40	45	50	60	V
Maximum average forward rectified current	$I_{(AV)}$				10		A
Peak forward surge current 8.3mS single half sine-wave superimposed on rated load (JEDEC method)	I_{FSM}				125		A
Maximum instantaneous forward voltage at 5.0A	V_F			0.55		0.65	V
Maximum DC reverse current $T_A = 25^{\circ}\text{C}$ at rated DC blocking voltage $T_A = 100^{\circ}\text{C}$	I_R			1.0			mA
				30.0			
Typical junction capacitance (Note 1)	C_J			550			pF
Typical thermal resistance (Note 2)	R_{JC}			3.0			$^{\circ}\text{C/W}$
Operating junction temperature range	T_J			-65 to +125			$^{\circ}\text{C}$
Storage temperature range	T_{Stg}			-65 to +150			$^{\circ}\text{C}$

Notes: (1) Measured at 1MHz and applied reverse voltage of 4.0V D.C.
(2) Thermal resistance from Junction to case.



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Fig. 1- Forward Current Derating Curve

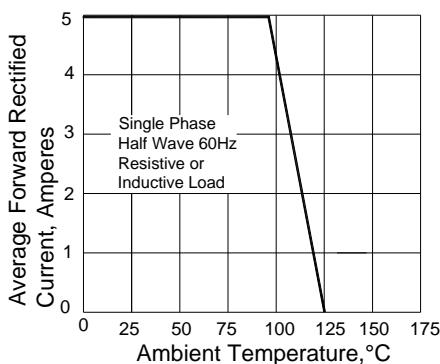


Fig.2-Maximum Non-repetitive Peak Forward Surge Current

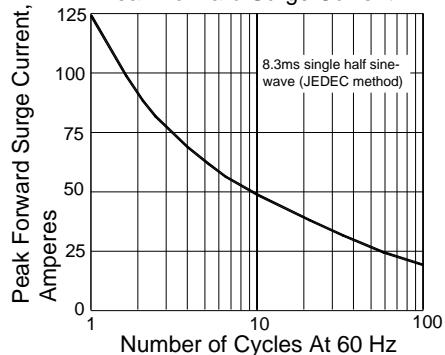


Fig. 3-Typical Instantaneous Forward Characteristics

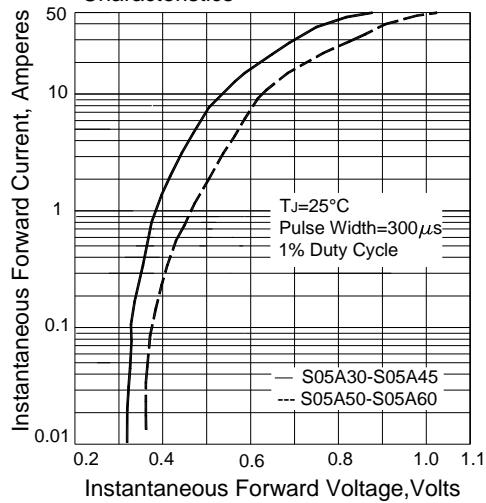


Fig. 4- Typical Reverse Characteristics

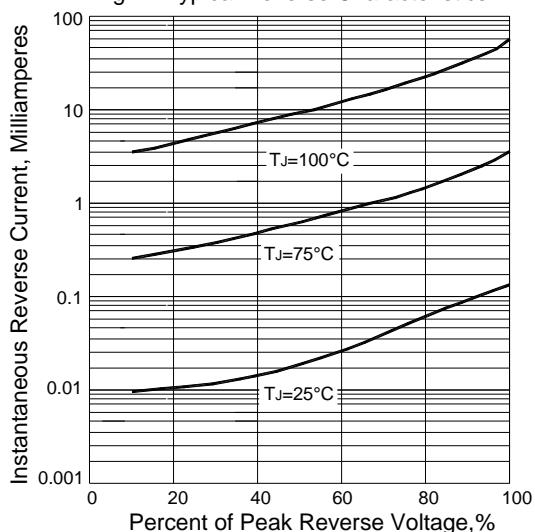


Fig. 5- Typical Junction Capacitance

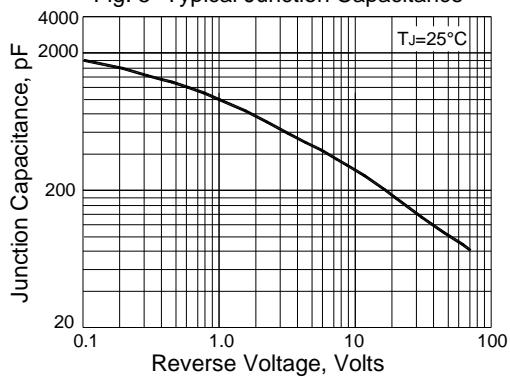


Fig. 6- Typical Transient Thermal Impedance

